

Multiphysics measurements of GaN Power Microwave Transistors

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Load Pull and TR system

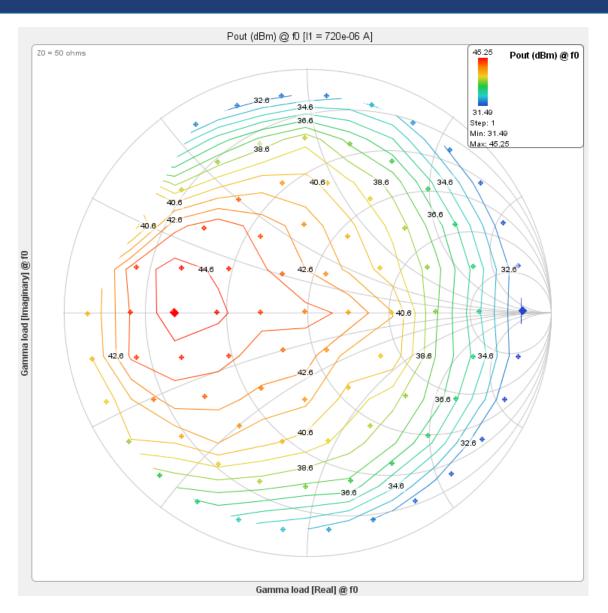






Max Power

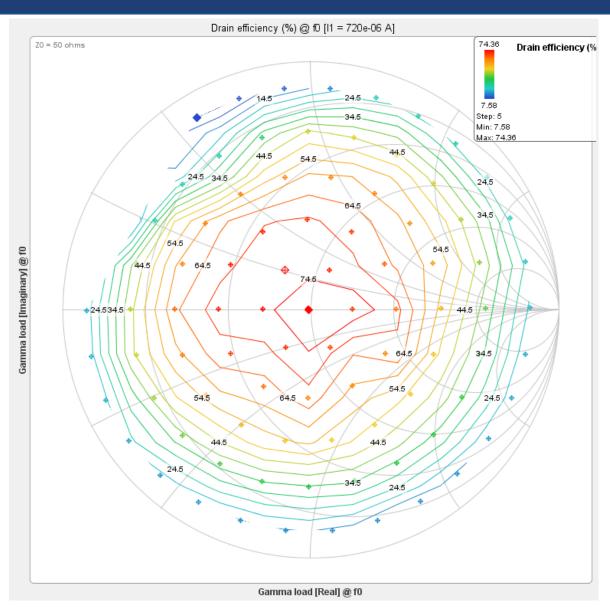






Max Efficiency

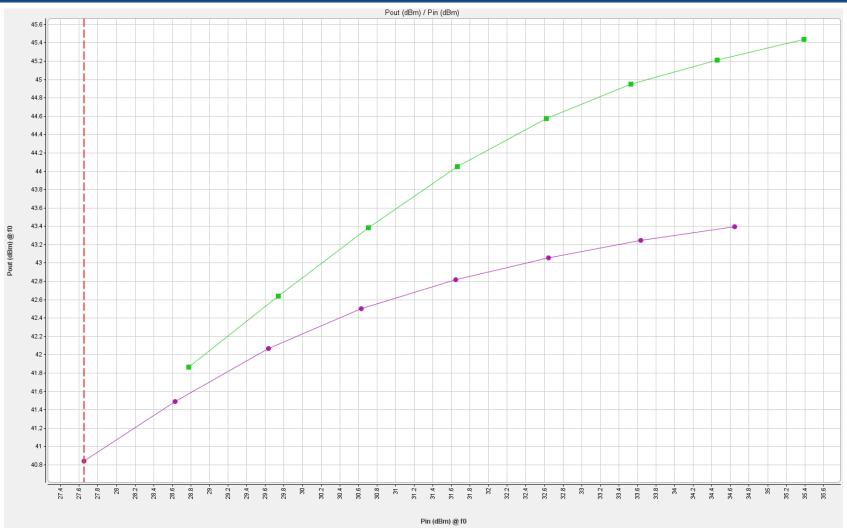






Pin vs Pout

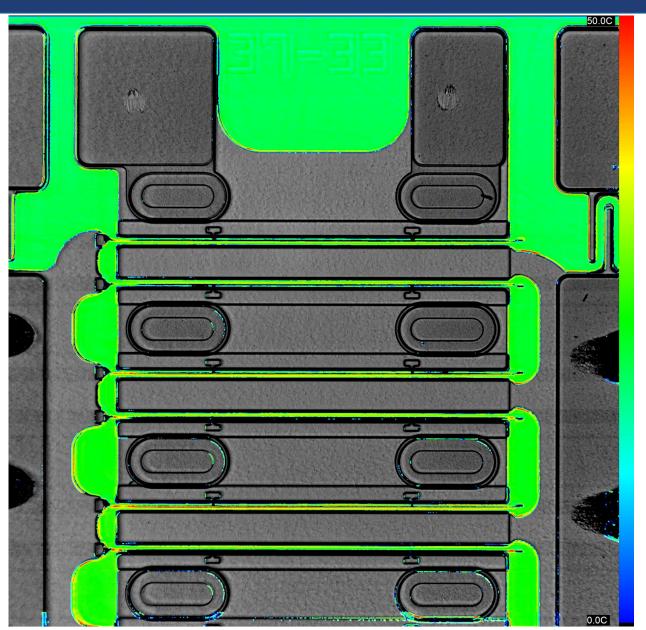






DC Thermal Measurements

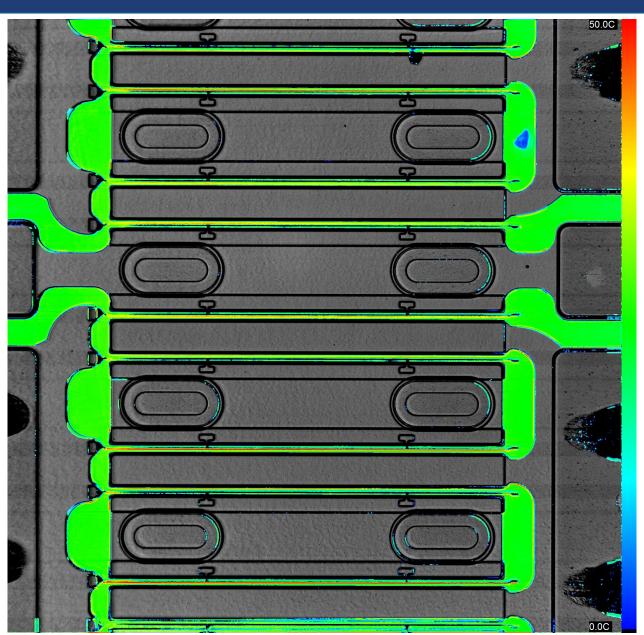






DC Thermal Measurements

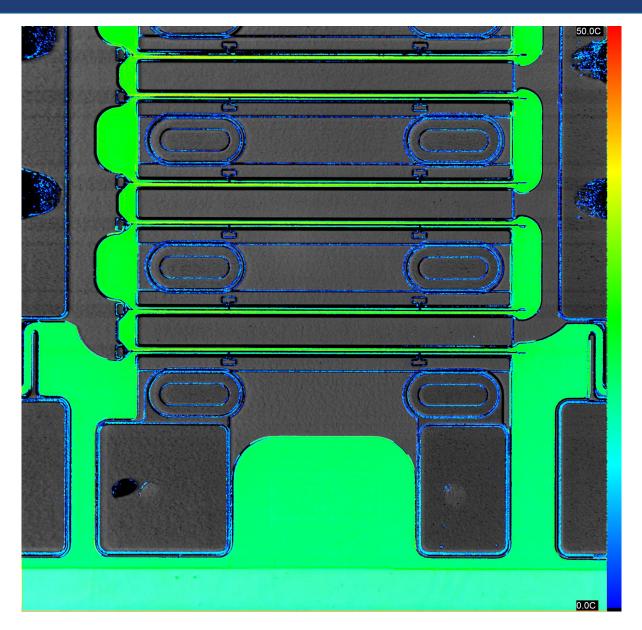






DC Thermal Measurements

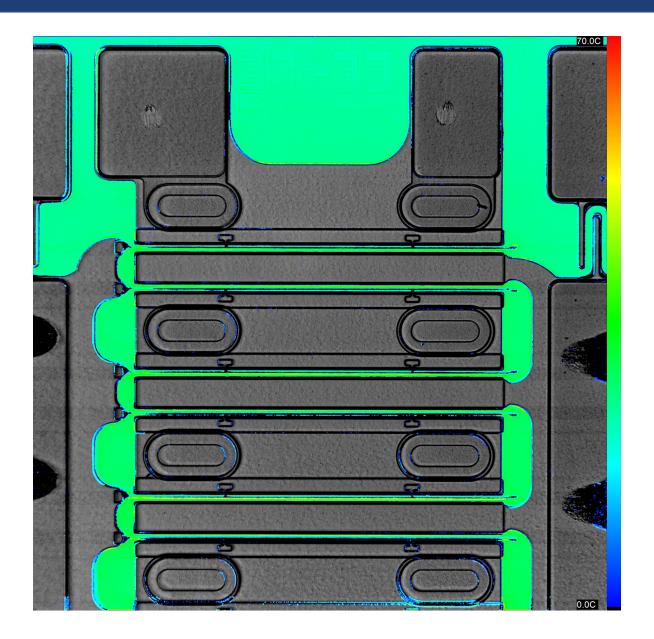






Max Eff Thermal Measurements

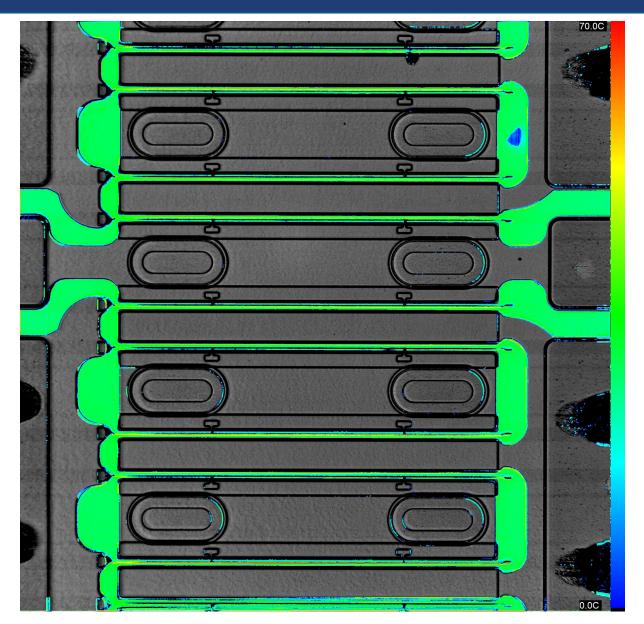






Max Eff Thermal Measurements

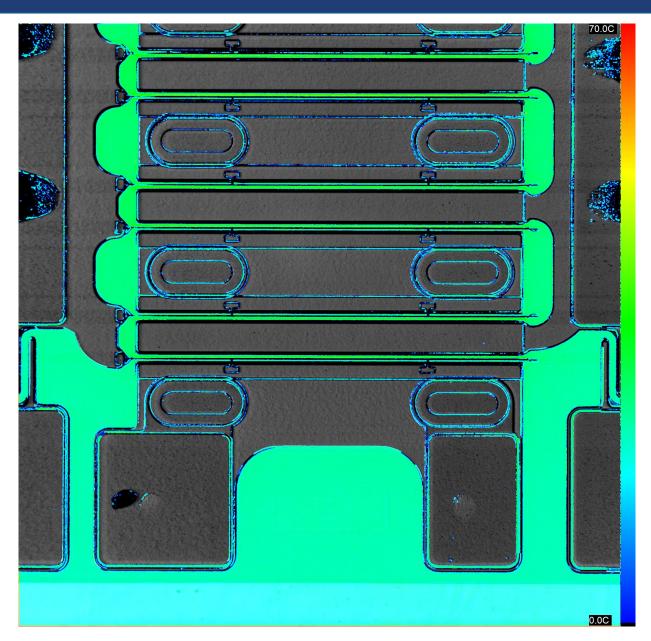






Max Eff Thermal Measurements

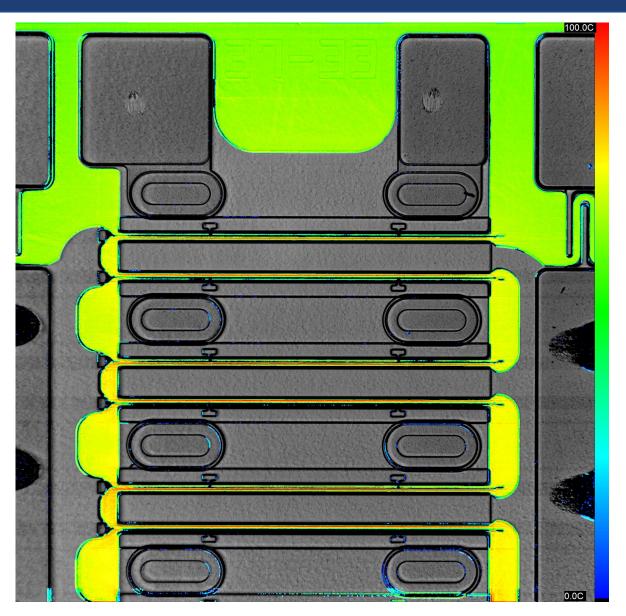






Max Power Thermal Measurement

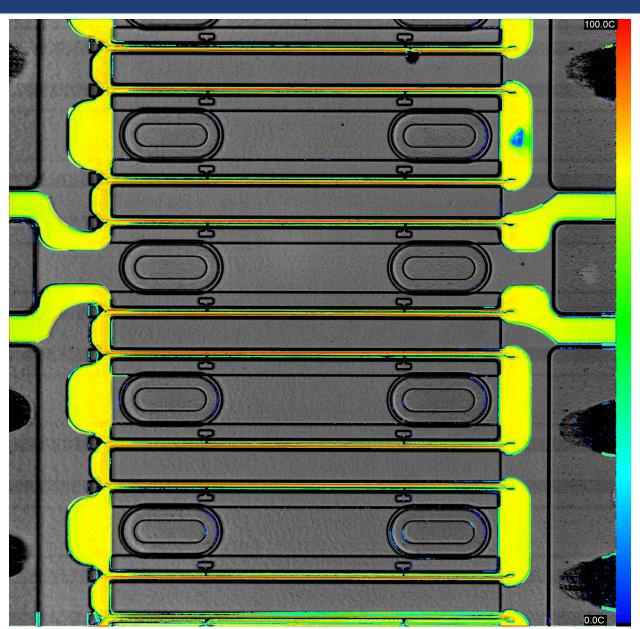






Max Power Thermal Measurement

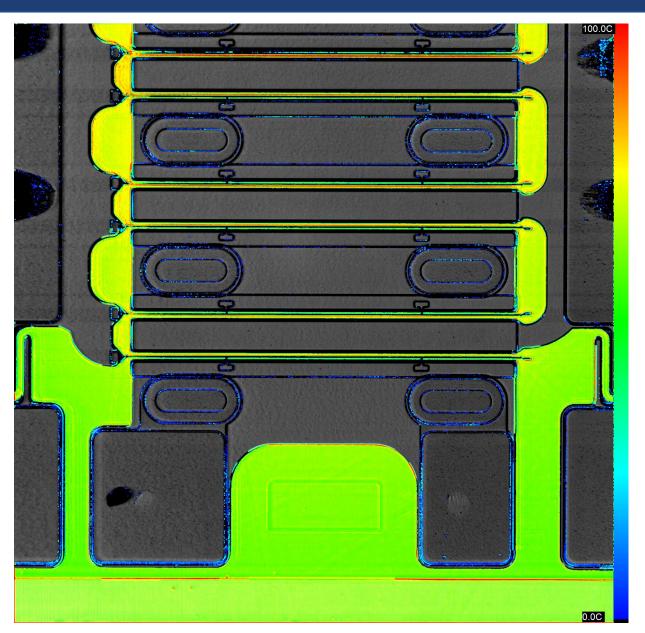






Max Power Thermal Measurement



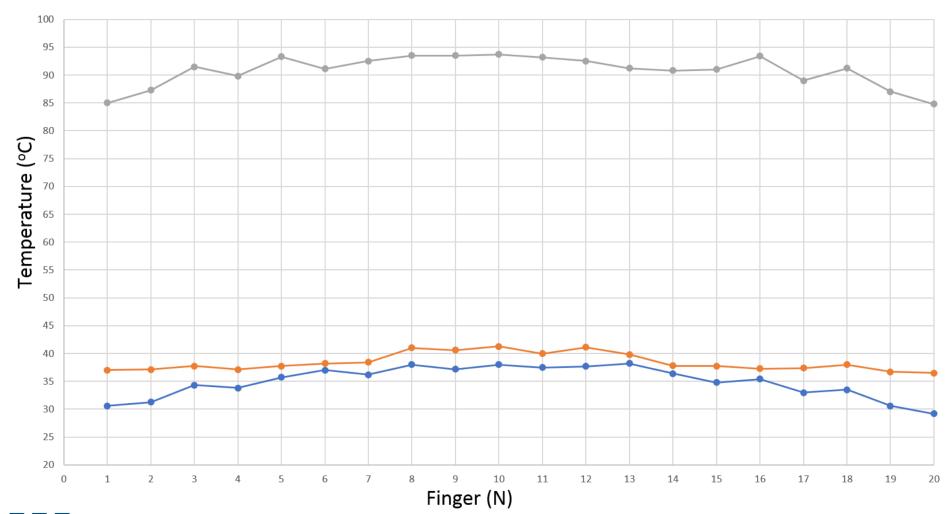




Thermoreflectance Results



Temperature vs Transistor Finger for DC, Max Efficiency and Max Power

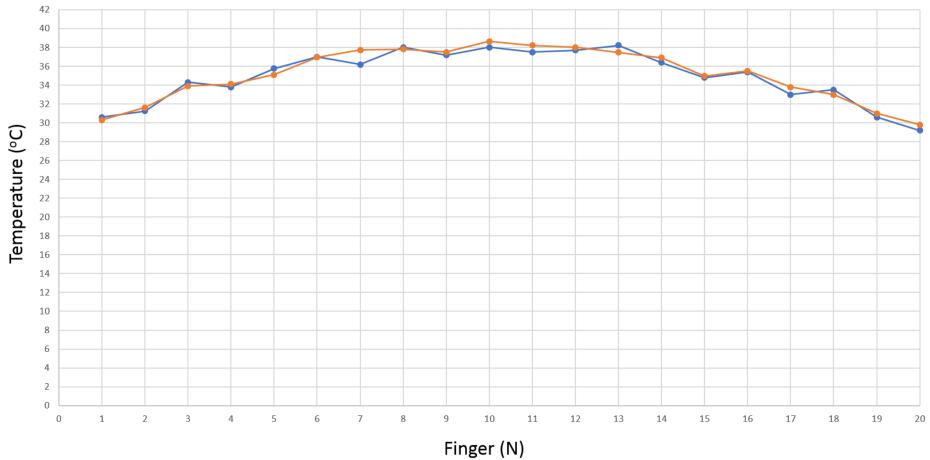




Measurement results 20x vs 40x



DC Temperature at 20x and 40x Magnification







Thank you for your attention

